#### SN54ABT16240A, SN74ABT16240A 16-BIT BUFFERS/DRIVERS WITH 3-STATE OUTPUTS SCBS095G - DECEMBER 1991 - REVISED OCTOBER 1998

SN54ABT16240A . . . WD PACKAGE • **Members of the Texas Instruments** SN74ABT16240A . . . DGG, DGV, OR DL PACKAGE Widebus<sup>™</sup> Family (TOP VIEW) State-of-the-Art *EPIC-*II*B*<sup>™</sup> BiCMOS Design Significantly Reduces Power Dissipation 1 OE II 48 20E Typical V<sub>OLP</sub> (Output Ground Bounce) < 1 V 1Y1 2 47 1A1 at V<sub>CC</sub> = 5 V, T<sub>A</sub> =  $25^{\circ}$ C 1Y2 3 46 1A2 GND 4 45 GND Distributed V<sub>CC</sub> and GND Pin Configuration • 1Y3 5 44 🛛 1A3 **Minimizes High-Speed Switching Noise** 1Y4 🛛 6 43 🛛 1A4 Flow-Through Architecture Optimizes PCB V<sub>CC</sub> [] 7 42 VCC Layout 2Y1 8 41 🛛 2A1 • High-Drive Outputs (-32-mA I<sub>OH</sub>, 64-mA I<sub>OL</sub>) 2Y2 9 40 2A2 Latch-Up Performance Exceeds 500 mA GND 10 39 GND Per JESD 17 2Y3 🛛 38 2A3 11 2Y4 🛛 12 ESD Protection Exceeds 2000 V Per 37 2A4 3Y1 🛛 13 MIL-STD-883. Method 3015: Exceeds 200 V 36 3A1 3Y2 [ Using Machine Model (C = 200 pF, R = 0) 14 35 🛛 3A2 GND [] 15 34 GND Package Options Include Plastic Shrink 3Y3 16 33 🛛 3A3 Small-Outline (DL), Thin Shrink 3Y4 117 32 3A4 Small-Outline (DGG), and Thin Very 31 V<sub>CC</sub> V<sub>CC</sub> [ 18 Small-Outline (DGV) Packages and 380-mil 4Y1 19 30 4A1 Fine-Pitch Ceramic Flat (WD) Package 4Y2 20 29 4A2 Using 25-mil Center-to-Center Spacings GND 21 28 GND 4Y3 22 27 4A3

#### description

The 'ABT16240A devices are 16-bit buffers and line drivers designed specifically to improve both the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters.

These devices can be used as four 4-bit buffers, two 8-bit buffers, or one 16-bit buffer. These devices provide inverting outputs and symmetrical active-low output-enable ( $\overline{OE}$ ) inputs.

4Y4 23

40E 24 26 4A4

25 30E

To ensure the high-impedance state during power up or power down, OE should be tied to V<sub>CC</sub> through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN54ABT16240A is characterized for operation over the full military temperature range of -55°C to 125°C. The SN74ABT16240A is characterized for operation from -40°C to 85°C.



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Copyright © 1998, Texas Instruments Incorporated On products compliant to MIL-PRF-38535, all parameters are tested unless otherwise noted. On all other products, production processing does not necessarily include testing of all parameters.

# SN54ABT16240A, SN74ABT16240A 16-BIT BUFFERS/DRIVERS WITH 3-STATE OUTPUTS SCBS095G – DECEMBER 1991 – REVISED OCTOBER 1998

| FUNC  | TION  | TABLE   |
|-------|-------|---------|
| (oach | 1-bit | huffor) |

| (ea | (each 4-bit buffer) |        |  |  |  |  |  |  |  |  |  |
|-----|---------------------|--------|--|--|--|--|--|--|--|--|--|
| INP | UTS                 | OUTPUT |  |  |  |  |  |  |  |  |  |
| OE  | Α                   | Y      |  |  |  |  |  |  |  |  |  |
| L   | Н                   | L      |  |  |  |  |  |  |  |  |  |
| L   | L                   | Н      |  |  |  |  |  |  |  |  |  |
| Н   | Х                   | Z      |  |  |  |  |  |  |  |  |  |

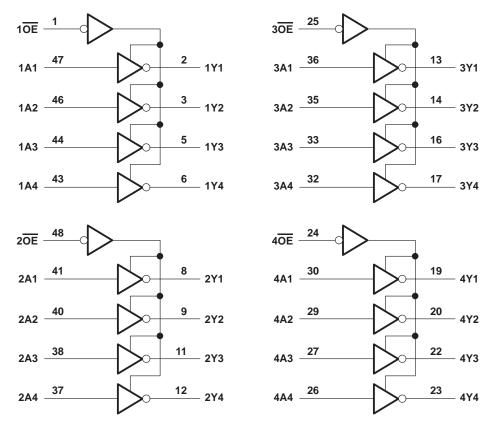
## logic symbol<sup>†</sup>

| 1 <mark>0E</mark> | 1  | EN1      |   |            |    |              |
|-------------------|----|----------|---|------------|----|--------------|
| 2 <mark>0E</mark> | 48 | EN2      |   |            |    |              |
| 3 <mark>0E</mark> | 25 | EN3      |   |            |    |              |
| 4 <u>0</u> E      | 24 | EN4      |   |            |    |              |
| 40E               |    |          |   | _          |    |              |
| 1A1               | 47 | ┍┻━━     | 1 | 1 ▽        | 2  | - 1Y1        |
| 1A2               | 46 |          |   | I V        | 3  |              |
| 1A2               | 44 |          |   |            | 5  | - 1Y3        |
| 1A3               | 43 |          |   |            | 6  | - 1Y4        |
| 2A1               | 41 |          | 1 | 2 ▽        | в  |              |
| 2A1               | 40 | ├──      | • | - •        | g  | – 2Y2        |
| 2A2               | 38 |          |   |            | 11 | - 2Y3        |
| 2A3<br>2A4        | 37 |          |   |            | 12 | 213<br>- 2Y4 |
| 2A4<br>3A1        | 36 |          | 1 | 3 ▽        | 13 | - 3Y1        |
| 3A2               | 35 |          |   | <b>J</b> v | 14 | - 3Y2        |
| 3A3               | 33 |          |   |            | 16 | - 3Y3        |
| 3A4               | 32 | <u> </u> |   |            | 17 | - 3Y4        |
| 4A1               | 30 | <u> </u> | 1 | 4 ▽        | 19 |              |
| 4A1               | 29 | <u> </u> |   |            | 20 |              |
| 4A2               | 27 | <u> </u> |   |            | 22 | - 4Y3        |
| 4A3<br>4A4        | 26 | <u> </u> |   |            | 23 |              |
| -1-1-1            |    |          |   |            |    | 414          |

<sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.



#### logic diagram (positive logic)



#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

| Supply voltage range, V <sub>CC</sub> –   | 0.5 V to 7 V |
|---|--------------|
| Input voltage range, VI (see Note 1) –  | 0.5 V to 7 V |
| Voltage range applied to any output in the high or power-off state, V <sub>O</sub> 0. | 5 V to 5.5 V |
| Current into any output in the low state, I <sub>O</sub> : SN54ABT16240A              | 96 mA        |
| SN74ABT16240A   | 128 mA       |
| Input clamp current, I <sub>IK</sub> (V <sub>I</sub> < 0)                             | –18 mA       |
| Output clamp current, I <sub>OK</sub> (V <sub>O</sub> < 0)                            | –50 mA       |
| Package thermal impedance, $\theta_{JA}$ (see Note 2): DGG package                    | 89°C/W       |
| DGV package   | 93°C/W       |
| DL package  | 94°C/W       |
| Storage temperature range, T <sub>stg</sub> 65  |              |

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51.



# SN54ABT16240A, SN74ABT16240A **16-BIT BUFFERS/DRIVERS** WITH 3-STATE OUTPUTS

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#### recommended operating conditions (see Note 3)

|                     |                                    |                 | SN54ABT | 16240A | SN74ABT | 16240A | UNIT |
|---------------------|------------------------------------|-----------------|---------|--------|---------|--------|------|
|                     |                                    |                 | MIN     | MAX    | MIN     | MAX    | UNIT |
| V <sub>CC</sub>     | Supply voltage                     |                 | 4.5     | 5.5    | 4.5     | 5.5    | V    |
| VIH                 | High-level input voltage           |                 | 2       |        | 2       |        | V    |
| VIL                 | Low-level input voltage            |                 |         | 0.8    |         | 0.8    | V    |
| VI                  | Input voltage                      |                 | 0       | VCC    | 0       | VCC    | V    |
| ЮН                  | High-level output current          |                 |         | -24    |         | -32    | mA   |
| IOL                 | Low-level output current           |                 |         | 48     |         | 64     | mA   |
| $\Delta t/\Delta v$ | Input transition rise or fall rate | Outputs enabled |         | 10     |         | 10     | ns/V |
| Т <sub>А</sub>      | Operating free-air temperature     |                 | -55     | 125    | -40     | 85     | °C   |

NOTE 3: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

|                  |                | TEST CO   | NDITIONS                                     | Т   | A = 25°C | ;     | SN54ABT | 16240A | SN74ABT1 | 6240A | LINUT |
|------------------|----------------|---|--|-----|----------|-------|---------|--------|----------|-------|-------|
| PARA             | METER          | IESI CO   | NDITIONS                                     | MIN | TYP†     | MAX   | MIN     | MAX    | MIN      | MAX   | UNIT  |
| VIK              |                | V <sub>CC</sub> = 4.5 V,  | lj = -18 mA                                  |     |          | -1.2  |         | -1.2   |          | -1.2  | V     |
|                  |                | V <sub>CC</sub> = 4.5 V,  | I <sub>OH</sub> = –3 mA                      | 2.5 |          |       | 2.5     |        | 2.5      |       |       |
| \/               |                | V <sub>CC</sub> = 5 V,  | I <sub>OH</sub> = –3 mA                      | 3   |          |       | 3       |        | 3        |       | V     |
| VOH              |                | V <sub>CC</sub> = 4.5 V   | I <sub>OH</sub> = -24 mA                     | 2   |          |       | 2       |        |          |       | v     |
|                  |                | VCC = 4.5 V   | I <sub>OH</sub> = -32 mA                     | 2*  |          |       |         |        | 2        |       |       |
| Val              |                |   | I <sub>OL</sub> = 48 mA                      |     |          | 0.55  |         | 0.55   |          |       | V     |
| VOL              |                | V <sub>CC</sub> = 4.5 V   | I <sub>OL</sub> = 64 mA                      |     |          | 0.55* |         |        |          | 0.55  | v     |
| V <sub>hys</sub> |                |   |  |     | 100      |       |         |        |          |       | mV    |
| lj               |                | V <sub>CC</sub> = 5.5 V,  | $V_I = V_{CC} \text{ or } GND$               |     |          | ±1    |         | ±1     |          | ±1    | μA    |
| IOZH             |                | V <sub>CC</sub> = 5.5 V,  | V <sub>O</sub> = 2.7 V                       |     |          | 10    |         | 10     |          | 10    | μA    |
| I <sub>OZL</sub> |                | V <sub>CC</sub> = 5.5 V,  | $V_{O} = 0.5 V$                              |     |          | -10   |         | -10    |          | -10   | μA    |
| loff             |                | $V_{CC} = 0,$   | $V_{I} \text{ or } V_{O} \leq 4.5 \text{ V}$ |     |          | ±100  |         |        |          | ±100  | μA    |
| ICEX             |                | V <sub>CC</sub> = 5.5 V,<br>V <sub>O</sub> = 5.5 V                              | Outputs high                                 |     |          | 50    |         | 50     |          | 50    | μΑ    |
| IO‡              |                | V <sub>CC</sub> = 5.5 V,  | V <sub>O</sub> = 2.5 V                       | -50 | -100     | -180  | -50     | -180   | -50      | -180  | mA    |
|                  |                | V <sub>CC</sub> = 5.5 V,  | Outputs high                                 |     |          | 3     |         | 3      |          | 3     |       |
| ICC              |                | $I_{O} = 0,$  | Outputs low                                  |     |          | 34    |         | 34     |          | 34    | mA    |
|                  |                | $V_{I} = V_{CC} \text{ or } GND$  | Outputs disabled                             |     |          | 3     |         | 3      |          | 3     |       |
|                  | Data           | $V_{CC} = 5.5 V$ ,<br>One input at 3.4 V,                                       | Outputs enabled                              |     |          | 1     |         | 1.5    |          | 1     |       |
| ∆ICC§            | inputs         | Other inputs at V <sub>CC</sub> or GND  | Outputs disabled                             |     |          | 0.05  |         | 1      |          | 0.05  | mA    |
|                  | Control inputs | $V_{CC}$ = 5.5 V, One input at 3.4 V,<br>Other inputs at V <sub>CC</sub> or GND |  |     |          | 1.5   |         | 1.5    |          | 1.5   |       |
| Ci               | -              | V <sub>I</sub> = 2.5 V or 0.5 V   |  |     | 3.5      |       |         |        |          |       | pF    |
| Co               |                | $V_{O} = 2.5 \text{ V or } 0.5 \text{ V}$                                       |  |     | 7.5      |       |         |        |          |       | рF    |

\* On products compliant to MIL-PRF-38535, this parameter does not apply.

<sup>†</sup> All typical values are at  $V_{CC} = 5$  V.

<sup>‡</sup>Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

§ This is the increase in supply current for each input that is at the specified TTL voltage level rather than V<sub>CC</sub> or GND.



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# switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 1)

| PARAMETER        | FROM<br>(INPUT) | TO<br>(OUTPUT) | V(<br>Tj | CC = 5 V<br>A = 25°C | l,<br>; | MIN | МАХ | UNIT |
|------------------|-----------------|----------------|----------|----------------------|---------|-----|-----|------|
|                  |                 |                | MIN      | TYP                  | MAX     |     |     |      |
| <sup>t</sup> PLH | ٨               | V              | 0.8      | 2.7                  | 3.8     | 0.8 | 4.8 | ns   |
| <sup>t</sup> PHL | A               | '              | 1.1      | 3.1                  | 4.3     | 1.1 | 4.9 | 115  |
| <sup>t</sup> PZH | OE              | V              | 1.3      | 3.3                  | 4.3     | 1.3 | 5.4 | ns   |
| tPZL             | UE              | I              | 1.4      | 3.4                  | 6.2     | 1.4 | 7.2 | 115  |
| <sup>t</sup> PHZ | OE              | v              | 1.6      | 3.6                  | 6.2     | 1.6 | 7.2 | ns   |
| <sup>t</sup> PLZ | UE              | ſ              | 1.4      | 3                    | 5.1     | 1.4 | 5.7 | 115  |

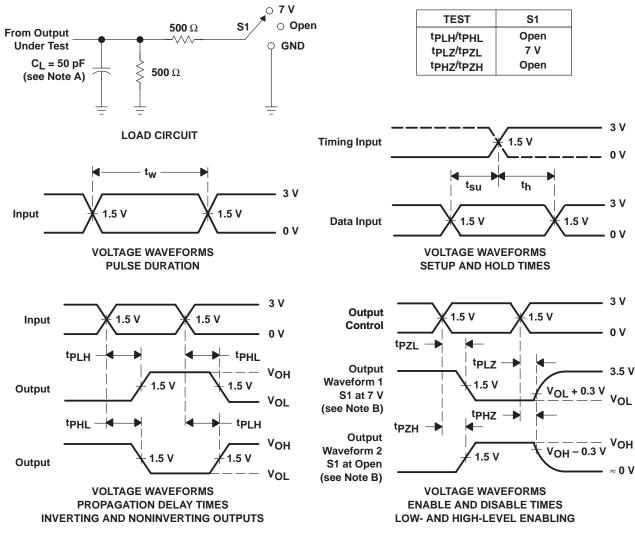
# switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 1)

| PARAMETER        | FROM<br>(INPUT) | TO<br>(OUTPUT) | V(<br>Tj | CC = 5 V<br>A = 25°C | l,<br>; | MIN | МАХ | UNIT |
|------------------|-----------------|----------------|----------|----------------------|---------|-----|-----|------|
|                  |                 |                | MIN      | TYP                  | MAX     |     |     |      |
| <sup>t</sup> PLH | А               | v              | 1        | 2.7                  | 3.8     | 1   | 4.7 | ns   |
| <sup>t</sup> PHL | A               |                | 1.1      | 3.1                  | 4.3     | 1.1 | 4.8 | 115  |
| <sup>t</sup> PZH | OE              | v              | 1.3      | 3.3                  | 4.3     | 1.3 | 5.3 | ns   |
| <sup>t</sup> PZL | ÛE              | T              | 1.4      | 3.4                  | 6.2     | 1.4 | 7.1 | 115  |
| <sup>t</sup> PHZ | OE              | v              | 1.6      | 3.6                  | 4.8     | 1.6 | 6.1 | ns   |
| <sup>t</sup> PLZ | UE              |                | 1.4      | 3                    | 5.1     | 1.4 | 5.6 | 115  |



## SN54ABT16240A, SN74ABT16240A **16-BIT BUFFERS/DRIVERS** WITH 3-STATE OUTPUTS

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#### PARAMETER MEASUREMENT INFORMATION

NOTES: A. CL includes probe and jig capacitance.

B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.

C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz, Z<sub>O</sub> = 50  $\Omega$ , t<sub>r</sub>  $\leq$  2.5 ns, t<sub>f</sub>  $\leq$  2.5 ns.

D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms





## PACKAGING INFORMATION

| Orderable Device  | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2)     | Lead finish/<br>Ball material<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5)                     | Samples |
|-------------------|---------------|--------------|--------------------|------|----------------|---------------------|--------------------------------------|----------------------|--------------|---|---------|
| 5962-9319901MXA   | ACTIVE        | CFP          | WD                 | 48   | 1              | Non-RoHS<br>& Green | SNPB                                 | N / A for Pkg Type   | -55 to 125   | 5962-9319901MX<br>A<br>SNJ54ABT16240A<br>WD | Samples |
| SN74ABT16240ADGGR | ACTIVE        | TSSOP        | DGG                | 48   | 2000           | RoHS & Green        | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 85    | ABT16240A                                   | Samples |
| SN74ABT16240ADGVR | ACTIVE        | TVSOP        | DGV                | 48   | 2000           | RoHS & Green        | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 85    | AH240A                                      | Samples |
| SN74ABT16240ADL   | ACTIVE        | SSOP         | DL                 | 48   | 25             | RoHS & Green        | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 85    | ABT16240A                                   | Samples |
| SN74ABT16240ADLG4 | ACTIVE        | SSOP         | DL                 | 48   | 25             | RoHS & Green        | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 85    | ABT16240A                                   | Samples |
| SN74ABT16240ADLR  | ACTIVE        | SSOP         | DL                 | 48   | 1000           | RoHS & Green        | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 85    | ABT16240A                                   | Samples |
| SNJ54ABT16240AWD  | ACTIVE        | CFP          | WD                 | 48   | 1              | Non-RoHS<br>& Green | SNPB                                 | N / A for Pkg Type   | -55 to 125   | 5962-9319901MX<br>A<br>SNJ54ABT16240A<br>WD | Samples |

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.



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# PACKAGE OPTION ADDENDUM

<sup>(5)</sup> Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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#### OTHER QUALIFIED VERSIONS OF SN54ABT16240A, SN74ABT16240A :

• Catalog : SN74ABT16240A

• Military : SN54ABT16240A

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications



Texas

STRUMENTS

### TAPE AND REEL INFORMATION





#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



| *All dimensions are nominal |                 |                    |    |      |                          |                          |            |            |            |            |           |                  |
|-----------------------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| Device                      | Package<br>Type | Package<br>Drawing |    | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
| SN74ABT16240ADGGR           | TSSOP           | DGG                | 48 | 2000 | 330.0                    | 24.4                     | 8.6        | 13.0       | 1.8        | 12.0       | 24.0      | Q1               |
| SN74ABT16240ADGVR           | TVSOP           | DGV                | 48 | 2000 | 330.0                    | 16.4                     | 7.1        | 10.2       | 1.6        | 12.0       | 16.0      | Q1               |
| SN74ABT16240ADLR            | SSOP            | DL                 | 48 | 1000 | 330.0                    | 32.4                     | 11.35      | 16.2       | 3.1        | 16.0       | 32.0      | Q1               |



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# PACKAGE MATERIALS INFORMATION

3-Jun-2022



\*All dimensions are nominal

| Device            | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74ABT16240ADGGR | TSSOP        | DGG             | 48   | 2000 | 367.0       | 367.0      | 45.0        |
| SN74ABT16240ADGVR | TVSOP        | DGV             | 48   | 2000 | 356.0       | 356.0      | 35.0        |
| SN74ABT16240ADLR  | SSOP         | DL              | 48   | 1000 | 367.0       | 367.0      | 55.0        |

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## TUBE



## - B - Alignment groove width

\*All dimensions are nominal

| Device            | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (µm) | B (mm) |
|-------------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| SN74ABT16240ADL   | DL           | SSOP         | 48   | 25  | 473.7  | 14.24  | 5110   | 7.87   |
| SN74ABT16240ADLG4 | DL           | SSOP         | 48   | 25  | 473.7  | 14.24  | 5110   | 7.87   |

# **MECHANICAL DATA**

MCFP010B - JANUARY 1995 - REVISED NOVEMBER 1997

#### **CERAMIC DUAL FLATPACK**

#### WD (R-GDFP-F\*\*)

48 LEADS SHOWN



- NOTES: A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package can be hermetically sealed with a ceramic lid using glass frit.
  - D. Index point is provided on cap for terminal identification only
  - E. Falls within MIL STD 1835: GDFP1-F48 and JEDEC MO-146AA
    - GDFP1-F56 and JEDEC MO-146AB



# **MECHANICAL DATA**

PLASTIC SMALL-OUTLINE

MPDS006C - FEBRUARY 1996 - REVISED AUGUST 2000

### DGV (R-PDSO-G\*\*)

24 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.
- D. Falls within JEDEC: 24/48 Pins MO-153

14/16/20/56 Pins – MO-194



DL (R-PDSO-G48)

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MO-118

PowerPAD is a trademark of Texas Instruments.



# **PACKAGE OUTLINE**

# TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
  This drawing is subject to change without notice.
  This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not

- exceed 0.15 mm per side. 4. Reference JEDEC registration MO-153.



# **DGG0048A**

# DGG0048A

# **EXAMPLE BOARD LAYOUT**

# TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



NOTES: (continued)

5. Publication IPC-7351 may have alternate designs.

6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



# DGG0048A

# **EXAMPLE STENCIL DESIGN**

# TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate

design recommendations. 8. Board assembly site may have different recommendations for stencil design.



# **MECHANICAL DATA**

MTSS003D - JANUARY 1995 - REVISED JANUARY 1998

#### DGG (R-PDSO-G\*\*)

#### PLASTIC SMALL-OUTLINE PACKAGE

**48 PINS SHOWN** 



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-153



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